

ANTREX Electronics

Electronic Components Sourcing Information

Product Reference Information

Part Number: SPH0642HT5H-1

Manufacturer: Knowles

Package: Tape & Reel (TR)

Availability: Please confirm with sales

Product Page:

<https://antrexco.com/product/details/knowles/sph0642ht5h-1.html>

Request a Quote:

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Quality & Trust

New & Original Components

Supplier verification and packaging condition review

CoC / RoHS / REACH documents available on request

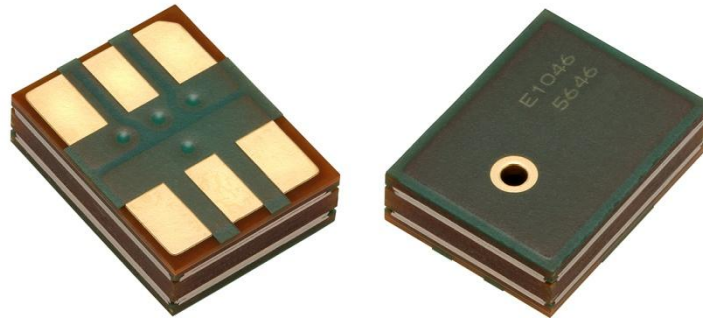
Secure sourcing support for OEM / EMS projects

Note:

This PDF includes an ANTREX product reference cover page.

The original manufacturer datasheet follows from the next page.

Wide Bandwidth, Low Noise, Precision Top Port SiSonic™ Microphone



The SPH0642HT5H-1 is a miniature, high-performance, low power, top port silicon microphone. Using Knowles' proven high performance SiSonic™ MEMS technology, the SPH0642HT5H-1 consists of an acoustic sensor, a low noise input buffer, and an output amplifier. These devices are suitable for applications such as cellphones, smart phones, laptop computers, sensors, digital still cameras, portable music recorders, and other portable electronic devices where excellent wideband audio performance and RF immunity are required.

Features:

- Matched Sensitivity
- Flat Frequency Response
- Low Noise
- Low Current
- Small package
- MaxRF protection
- Zero-Height Mic™
- Ultra-Stable Performance
- Standard SMD Reflow
- Omnidirectional

SPH0642HT5H-1

1. ABSOLUTE MAXIMUM RATINGS

Parameter	Absolute Maximum Rating	Units
V _{DD} to Ground	-0.5, +5.0	V
OUT to Ground	-0.3, V _{DD} + 0.3	V
Input Current to Any Pin	±5	mA
Temperature Range	-40 to +100	°C

Stresses exceeding these “Absolute Maximum Ratings” may cause permanent damage to the device. These are stress ratings only. Functional operation at these or any other conditions beyond those indicated under “Acoustic & Electrical Specifications” is not implied. Exposure beyond those indicated under “Acoustic & Electrical Specifications” for extended periods may affect device reliability.

2. ACOUSTIC & ELECTRICAL SPECIFICATIONS

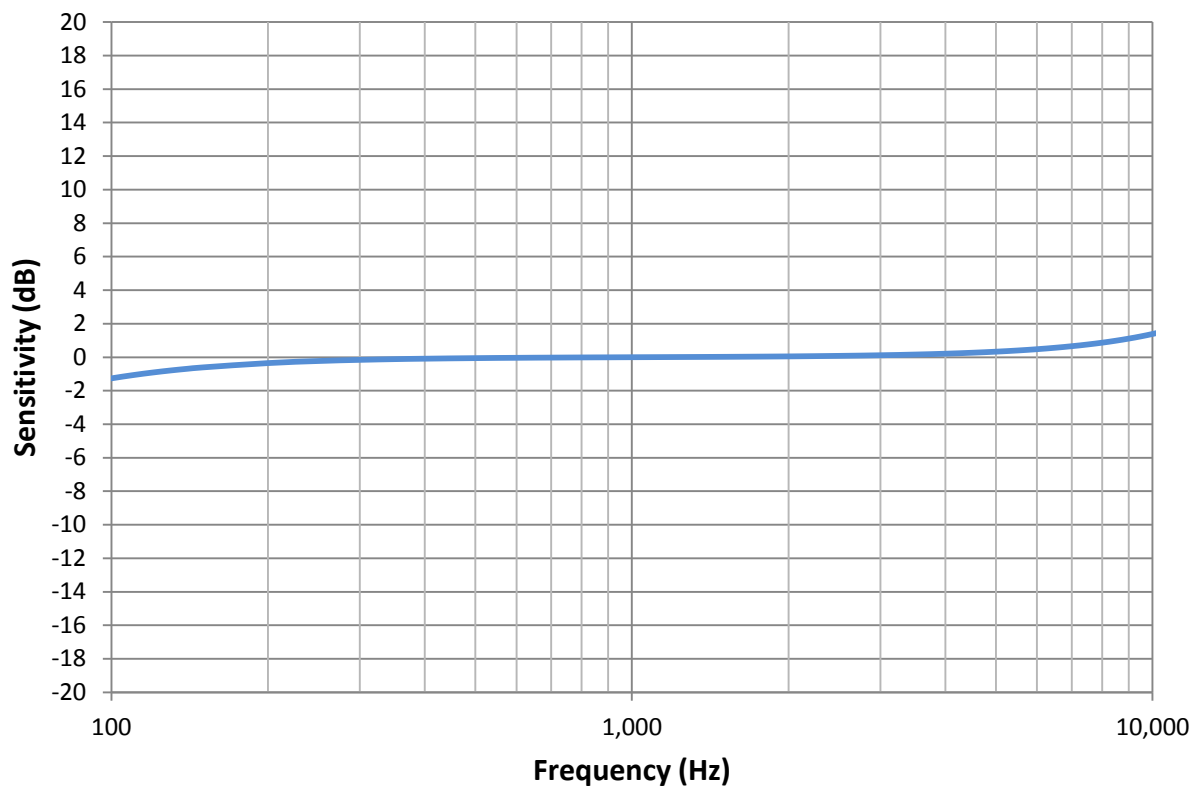
TEST CONDITIONS: 23 ±2°C, 55±20% R.H., V_{DD}(min) < V_{DD} < V_{DD}(max), no load, unless otherwise indicated

Parameter	Symbol	Conditions	Min	Typ	Max	Units
Supply Voltage ¹	V _{DD}		1.5	-	3.6	V
Supply Current ¹	I _{DD}	V _{DD} = 1.8V	-	117	130	μA
		V _{DD} = 3.6V	-	132	185	
Sensitivity ¹	S	94 dB SPL @ 1 kHz	-39	-38	-37	dBV/Pa
Signal to Noise Ratio	SNR	94 dB SPL @ 1 kHz, A-weighted	-	65	-	dB(A)
Total Harmonic Distortion	THD	94 dB SPL @ 1 kHz, S = Typ, R _{load} > 3 kΩ	-	.25	-	%
Acoustic Overload Point	AOP	10% THD @ 1 kHz, S = Typ, V _{DD} = 3.6V, R _{load} > 3 kΩ	-	124	-	dB SPL
Power Supply Rejection Ratio	PSRR	200mVpp sinewave @ 1 kHz, V _{DD} = 1.8V		78		dB
Power Supply Rejection	PSR	100 mVpp square wave @ 217 Hz, V _{DD} = 1.8V, A-weighted	-	-106		dBV(A)
DC Output		V _{DD} = 1.8V	-	1.3	-	V
Output Impedance	Z _{OUT}	@ 1 kHz	-	-	500	Ω
Directivity			Omnidirectional			
Polarity		Increasing sound pressure	Increasing output voltage			

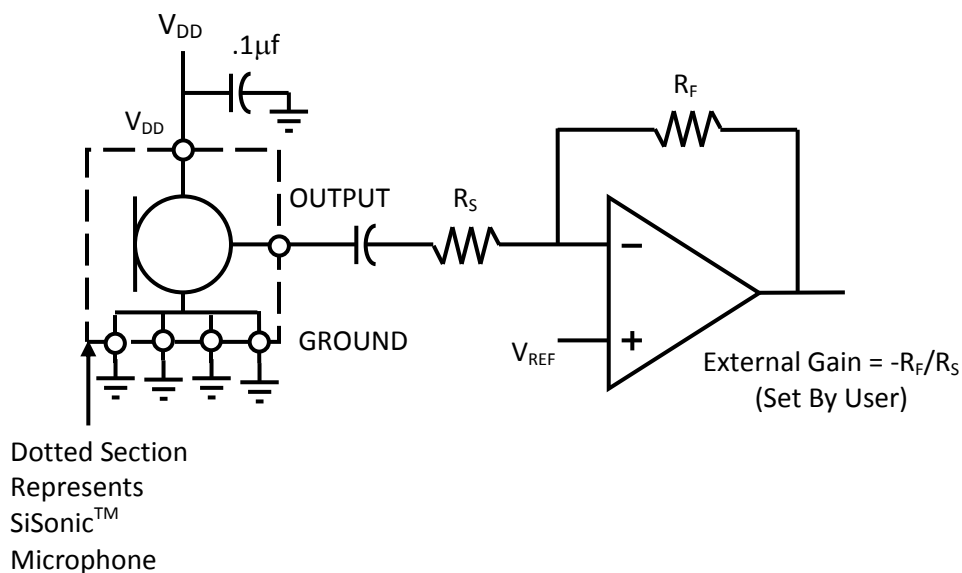
¹ 100% tested.

3. FREQUENCY RESPONSE CURVE

**Typical Free Field Response
Normalized to 1 kHz**



4. INTERFACE CIRCUIT

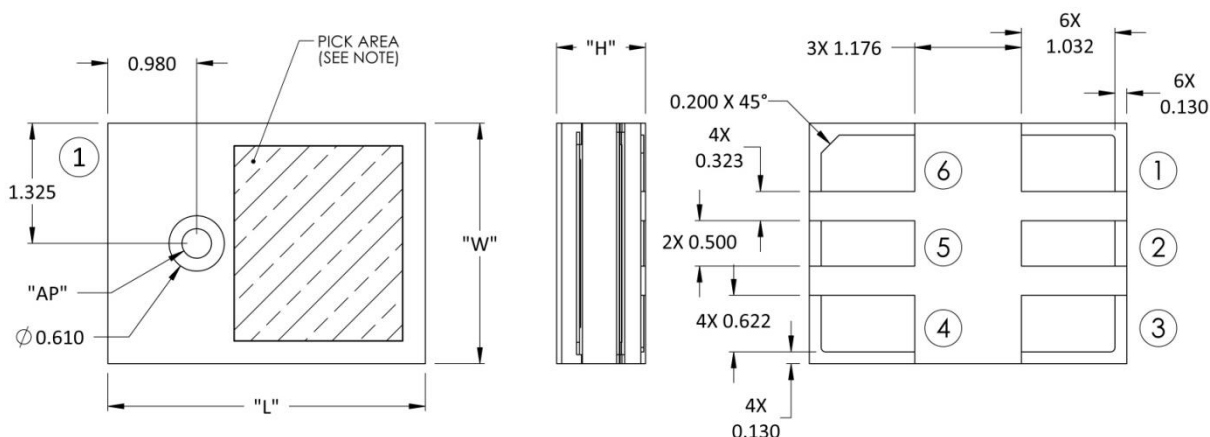


Notes: All Ground pins must be connected to ground.

Capacitors near the microphone should not contain Class 2 dielectrics.

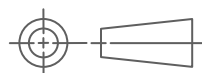
Detailed information on acoustic, mechanical, and system integration can be found in the latest *SiSonic™ Design Guide* application note.

5. MECHANICAL SPECIFICATIONS



Item	Dimension	Tolerance
Length (L)	3.50	±0.10
Width (W)	2.65	±0.10
Height (H)	1.00	±0.10
Acoustic Port (AP)	Ø0.325	±0.050

Pin #	Pin Name	Type	Description
1	GROUND	Power	Ground
2	GROUND	Power	Ground
3	GROUND	Power	Ground
4	OUTPUT	Signal	Output Signal
5	GROUND	Power	Ground
6	V _{DD}	Power	Power Supply

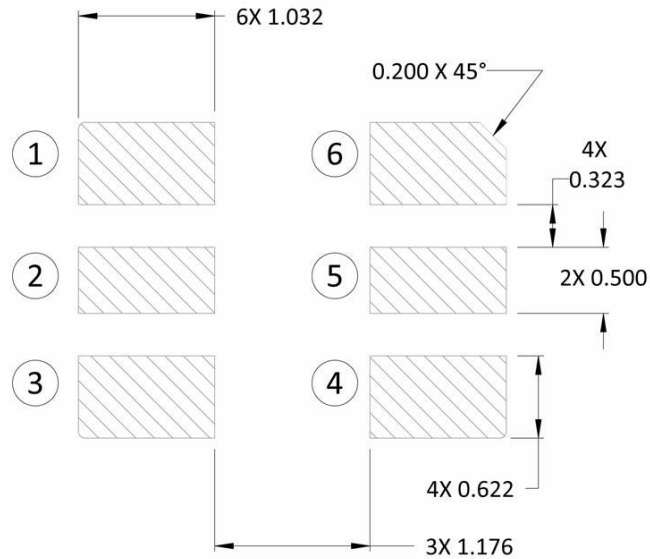


Notes: Pick Area only extends to 0.25 mm of any edge or hole unless otherwise specified.

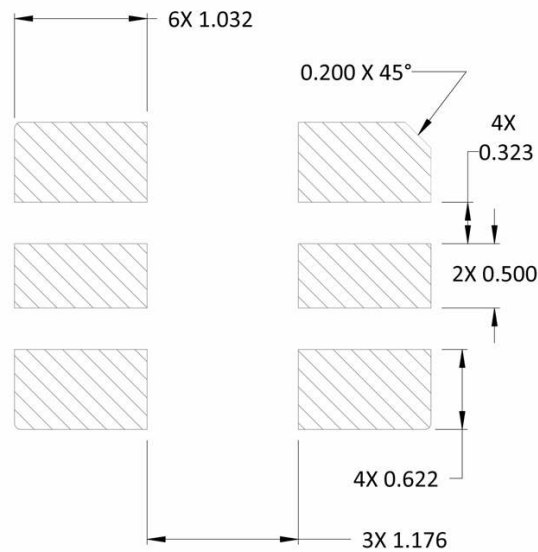
Dimensions are in millimeters unless otherwise specified.

Tolerance is ±0.15mm unless otherwise specified

6. EXAMPLE LAND PATTERN



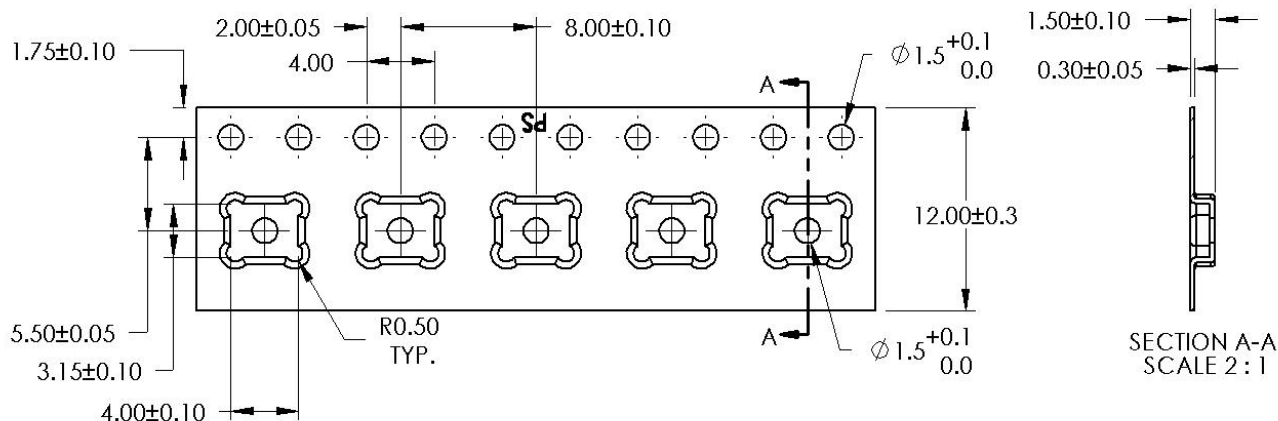
7. EXAMPLE SOLDER STENCIL PATTERN



Notes: Dimensions are in millimeters unless otherwise specified.

Further optimizations based on application should be performed.

8. PACKAGING & MARKING DETAIL



Model Number	Suffix	Reel Diameter	Quantity Per Reel
SPH0642HT5H-1	-8	13"	5,900

Alpha Character A:

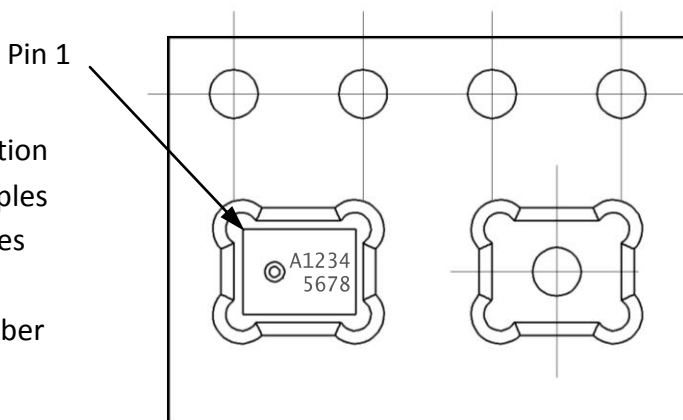
“S”: Knowles SiSonic™ Production

“E”: Knowles Engineering Samples

“P”: Knowles Prototype Samples

“12345678”:

Unique Job Identification Number
for product traceability



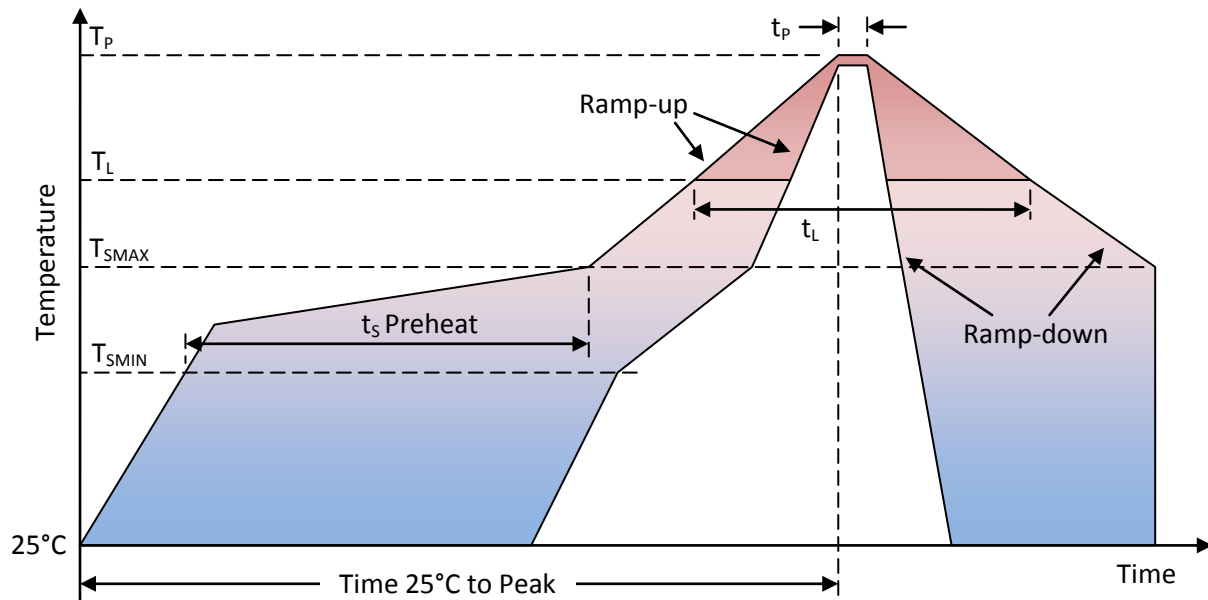
Notes: Dimensions are in millimeters unless otherwise specified.

Vacuum pickup only in the pick area indicated in Mechanical Specifications.

Tape & reel per EIA-481.

Labels applied directly to reel and external package.

9. RECOMMENDED REFLOW PROFILE



Profile Feature	Pb-Free
Average Ramp-up rate (T _S MAX to T _P)	3°C/second max.
Preheat - Temperature Min (T_SMIN) - Temperature Max (T_SMAX) - Time (T_SMIN to T_SMAX) (t_S)	150°C 200°C 60-180 seconds
Time maintained above: - Temperature (T_L) - Time (t_L)	217°C 60-150 seconds
Peak Temperature (T _P)	260°C
Time within 5°C of actual Peak Temperature (t _p)	20-40 seconds
Ramp-down rate (T _P to T _S MAX)	6°C/second max
Time 25°C to Peak Temperature	8 minutes max

Notes: Based on IPC/JDEC J-STD-020 Revision C.

All temperatures refer to topside of the package, measured on the package body surface.

10. ADDITIONAL NOTES

(A) Shelf life: Twelve (12) months when devices are to be stored in factory supplied, unopened ESD moisture sensitive bag under maximum environmental conditions of 30°C, 70% R.H.

(B) MSL (moisture sensitivity level) Class 1.

(C) Maximum of 3 reflow cycles is recommended.

(D) In order to minimize device damage:

- Do not board wash or clean after the reflow process.
- Do not brush board with or without solvents after the reflow process.
- Do not directly expose to ultrasonic processing, welding, or cleaning.
- Do not insert any object in port hole of device at any time.
- Do not apply over 30 psi of air pressure into the port hole.
- Do not pull a vacuum over port hole of the microphone.
- Do not apply a vacuum when repacking into sealed bags at a rate faster than 0.5 atm/sec.

11. MATERIALS STATEMENT

Meets the requirements of the European RoHS directive 2011/65/EC as amended.

Meets the requirements of the industry standard IEC 61249-2-21:2003 for halogenated substances and Knowles Green Materials Standards Policy section on Halogen-Free.

Ozone depleting substances are not used in the product or the processes used to make the product, including compounds listed in Annex A, B, and C of the “Montreal Protocol on Substances That Deplete the Ozone Layer.”

12. RELIABILITY SPECIFICATIONS

Test	Description
Thermal Shock	100 cycles air-to-air thermal shock from -40°C to +125°C with 15 minute soaks. (IEC 68-2-4)
High Temperature Storage	1,000 hours at +105°C environment (IEC 68-2-2 Test Ba)
Low Temperature Storage	1,000 hours at -40°C environment (IEC 68-2-2 Test Aa)
High Temperature Bias	1,000 hours at +105°C under bias (IEC 68-2-2 Test Ba)
Low Temperature Bias	1,000 hours at -40°C under bias (IEC 68-2-2 Test Aa)
Temperature / Humidity Bias	1,000 hours at +85°C/85% R.H. under bias. (JESD22-A101A-B)
Vibration	4 cycles of 20 to 2,000 Hz sinusoidal sweep with 20 G peak acceleration lasting 12 minutes in X, Y, and Z directions. (Mil-Std-883E, method 2007.2 A)
ESD-HBM	3 discharges of ±2 kV direct contact to I/O pins. (MIL 883E, Method 3015.7)
ESD-LID/GND	3 discharges of ±8 kV direct contact to lid while unit is grounded. (IEC 61000-4-2)
ESD-MM	3 discharges of ±200V direct contact to I/O pins. (ESD STM5.2)
Reflow	5 reflow cycles with peak temperature of +260°C
Mechanical Shock	3 pulses of 10,000 G in the X, Y, and Z direction (IEC 68-2-27, Test Ea)

Note: After reliability tests are performed, the sensitivity of the microphones shall not deviate more than 3 dB from its initial value.



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13. SPECIFICATION REVISIONS

Revision	Specification Changes	Date
A	Initial Release (C10115918)	4/25/2014

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